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(12) **United States Design Patent**  
**Yoshino et al.**

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(54) **HEADSET**

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381/380, 381, 374; 455/90.3, 575.1,  
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H04R 5/0335; H04R 25/00; H04R 1/10;  
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See application file for complete search history.

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(57) **CLAIM**

The ornamental design for a headset, as shown and described.

**DESCRIPTION**

The patent or application file contains at least one drawing executed in color. Copies of this patent or patent application publication with color drawings will be provided by the Office upon request and payment of the necessary fee.

FIG. 1 is a front elevational view of a headset showing the new design;

FIG. 2 is a rear elevational view of the headset;

FIG. 3 is a top plan view of the headset;

FIG. 4 is a bottom plan view of the headset;

FIG. 5 is a right side elevational view of the headset;

FIG. 6 is a left side elevational view of the headset;

FIG. 7 is a perspective view of the headset;

FIG. 8 is an enlarged partial view of the headset taken in the direction of lines 8-8 of FIG. 5;

FIG. 9 is an enlarged partial view of the headset taken in the direction of lines 9-9 of FIG. 6;

FIG. 10 is an enlarged partial view of the headset taken in the direction of lines 8-8 of FIG. 5 with the LED in an on position; and,

FIG. 11 is an enlarged bottom plan view of the headset in which the headphone is shown separately without the microphone for ease of illustration.

The broken lines and ghosted areas depict environment that forms no part of the claimed design.

**1 Claim, 11 Drawing Sheets**  
**(11 of 11 Drawing Sheet(s) Filed in Color)**



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***FIG. 1***





***FIG. 2***





***FIG. 3***



***FIG. 4***





**FIG. 5**



**FIG. 6**





**FIG. 7**





*FIG. 8*





***FIG. 9***





***FIG. 10***





*FIG. 11*

